



# SGM2358

## 1MHz, Rail-to-Rail Output, CMOS Operational Amplifier

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### GENERAL DESCRIPTION

The SGM2358 is a dual, voltage feedback amplifier. The device can operate from 2.5V to 5.5V single supply. It provides rail-to-rail output voltage swing. This feature makes SGM2358 appropriate for buffering ASIC.

The SGM2358 offers a gain-bandwidth product of 1MHz and an ultra-low input bias current of 10pA. It is well suited for piezoelectric sensors, integrators and photodiode amplifiers.

The SGM2358 is designed into a wide range of applications, such as battery-powered instrumentation, safety monitoring, portable systems, and transducer interface circuits in low power systems.

The SGM2358 is available in a Green SOIC-8 package. It is specified over the extended -40°C to +85°C temperature range.

### FEATURES

- **Low Cost**
- **Input Offset Voltage: 1.7mV (TYP)**
- **Ultra-Low Input Bias Current: 10pA**
- **Unity-Gain Stable**
- **Gain-Bandwidth Product: 1MHz**
- **Rail-to-Rail Output**
- **Supply Voltage Range: 2.5V to 5.5V**
- **Minimum Input Common Mode Voltage below 0V**
- **-40°C to +85°C Operating Temperature Range**
- **Available in a Green SOIC-8 Package**

### APPLICATIONS

ASIC Input or Output Amplifiers  
Piezoelectric Transducer Amplifiers  
Battery-Powered Equipment  
Portable Equipment  
Sensor Interfaces  
Medical Instrumentation  
Mobile Communications  
Smoke Detectors  
Notebook PCs  
PCMCIA Cards  
DSP Interfaces  
Set Top Boxes

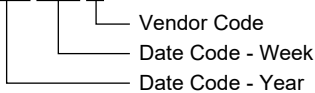
**PACKAGE/ORDERING INFORMATION**

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2358	SOIC-8	-40°C to +85°C	SGM2358YS/TR	SGM2358YS XXXXX	Tape and Reel, 4000

**MARKING INFORMATION**

NOTE: XXXXX = Date Code and Vendor Code.

**XXXXX**



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, +Vs to -Vs .....	6.0V
Package Thermal Resistance @ TA = +25°C	
SOIC-8, θJA .....	125°C/W
Junction Temperature .....	+160°C
Storage Temperature Range .....	-65°C to +150°C
Lead Temperature (Soldering, 10s) .....	+260°C
ESD Susceptibility	
HBM .....	4000V
MM .....	300V

**RECOMMENDED OPERATING CONDITIONS**

Operating Temperature Range .....	-40°C to +85°C
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**OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

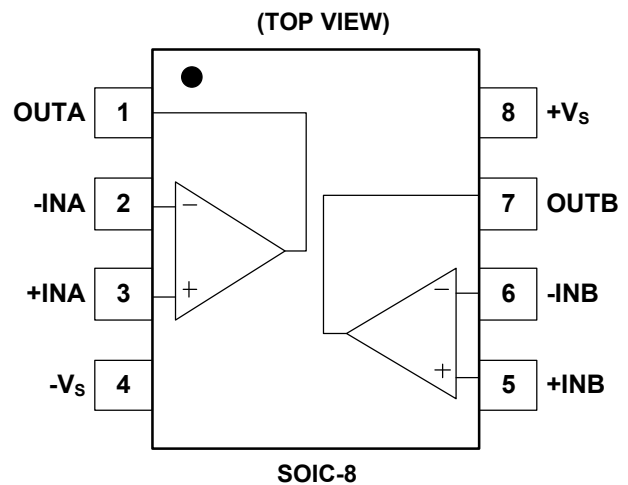
**ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

**DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

**PIN CONFIGURATION**



## ELECTRICAL CHARACTERISTICS

(V<sub>S</sub> = 5V, at R<sub>L</sub> = 100kΩ connected to V<sub>S</sub>/2, and V<sub>OUT</sub> = V<sub>S</sub>/2, unless otherwise noted.)

PARAMETER	CONDITIONS	SGM2358					
		TYP	MIN/MAX OVER TEMPERATURE			UNITS	MIN/MAX
		+25°C	+25°C	-40°C to +85°C			
<b>Input Characteristics</b>							
Input Offset Voltage (V <sub>OS</sub> )		1.7	10	10.5		mV	MAX
Input Bias Current (I <sub>B</sub> )		10				pA	TYP
Input Offset Current (I <sub>OS</sub> )		10				pA	TYP
Input Common Mode Voltage Range	V <sub>S</sub> = 5V		-0.1			V	MIN
			4			V	MAX
Common Mode Rejection Ratio (CMRR) <sup>(1)</sup>	V <sub>S</sub> = 5V, V <sub>CM</sub> = -0.1V to 3.3V	88	70	65		dB	MIN
Open-Loop Voltage Gain (A <sub>OL</sub> )	R <sub>L</sub> = 2kΩ, V <sub>OUT</sub> = 0.1V to 4.9V	100	80	70		dB	MIN
	R <sub>L</sub> = 10kΩ, V <sub>OUT</sub> = 0.035V to 4.965V	110	80	70		dB	MIN
Input Offset Voltage Drift (ΔV <sub>OS</sub> /ΔT)		3.5				μV/°C	TYP
<b>Output Characteristics</b>							
Output Voltage Swing from Rail	V <sub>OUT</sub> Connect R <sub>L</sub> (600Ω) to GND	0.139				V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (600Ω) to +V <sub>S</sub>	0.225				V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (2kΩ) to GND	0.080				V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (2kΩ) to +V <sub>S</sub>	0.087				V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (10kΩ) to GND	0.008				V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (10kΩ) to +V <sub>S</sub>	0.015				V	TYP
Output Current (I <sub>OUT</sub> )	V <sub>OUT</sub> = +V <sub>S</sub> - 0.5V	13				mA	TYP
	V <sub>OUT</sub> = -V <sub>S</sub> + 0.5V	-8				mA	TYP
Short-Circuit Current (I <sub>SC</sub> )	V <sub>OUT</sub> Connect R <sub>L</sub> (10Ω) to GND	43	35	30		mA	MIN
	V <sub>OUT</sub> Connect R <sub>L</sub> (10Ω) to +V <sub>S</sub>	-33	-20	-16		mA	MAX
<b>Power Supply</b>							
Operating Voltage Range			2.5	2.5		V	MIN
			5.5	5.5		V	MAX
Power Supply Rejection Ratio (PSRR)	V <sub>S</sub> = +2.5V to +5.5V V <sub>CM</sub> = (-V <sub>S</sub> ) + 0.5V	80	70	65		dB	MIN
Quiescent Current (I <sub>Q</sub> )	I <sub>OUT</sub> = 0	0.4	0.95	1		mA	MAX
<b>Dynamic Performance</b>							
Gain-Bandwidth Product (GBP)	C <sub>L</sub> = 100pF	1.0				MHz	TYP
Slew Rate (SR)	G = +1, 2V Output step	0.65				V/μs	TYP
Settling Time to 0.1% (t <sub>S</sub> )	G = +1, 2V Output step	9.0				μs	TYP
Overload Recovery Time	V <sub>IN</sub> • Gain = V <sub>S</sub>	4.0				μs	TYP
Crosstalk	f = 1kHz	-80				dB	TYP
	f = 1MHz	-65				dB	TYP
<b>Noise Performance</b>							
Voltage Noise Density (e <sub>n</sub> )	f = 1kHz	42				nV/√Hz	TYP
	f = 10kHz	38				nV/√Hz	TYP

## NOTE:

1. CMRR is affected by the matching between external gain-setting resistor ratios.

**ELECTRICAL CHARACTERISTICS (continued)**(V<sub>S</sub> = 2.5V, at R<sub>L</sub> = 100kΩ connected to V<sub>S</sub>/2, and V<sub>OUT</sub> = V<sub>S</sub>/2, unless otherwise noted.)

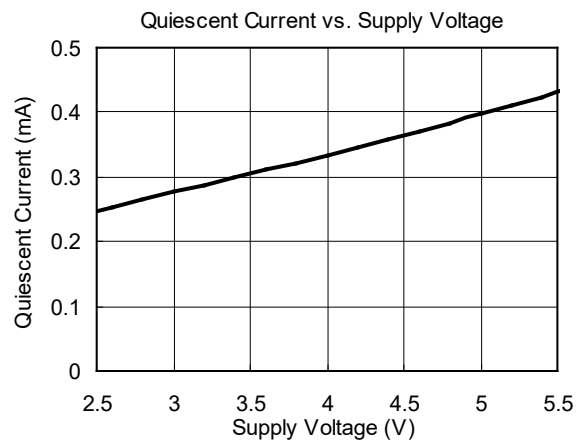
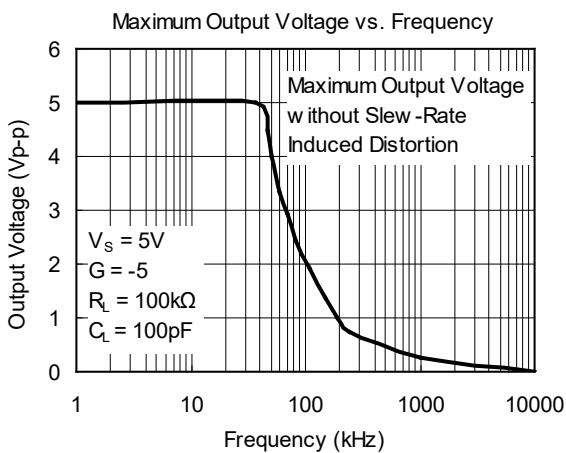
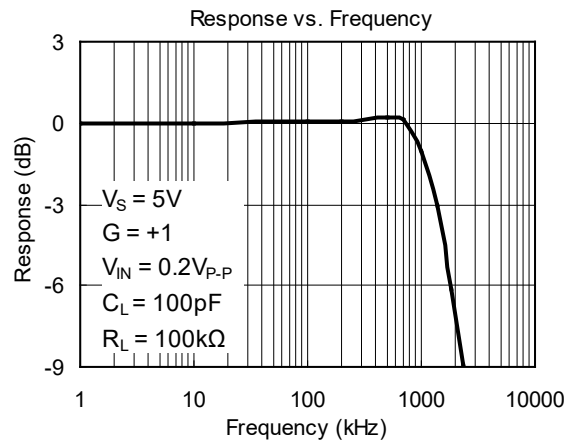
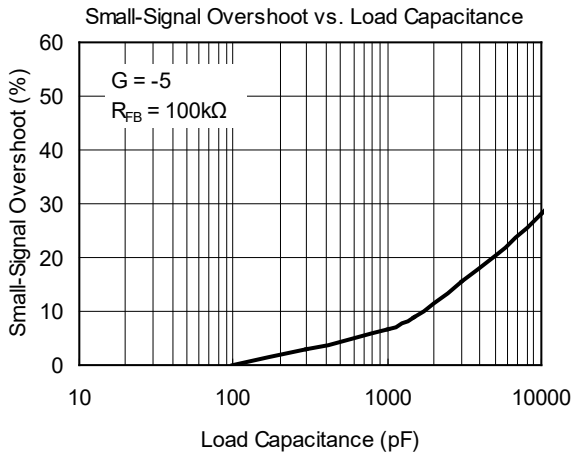
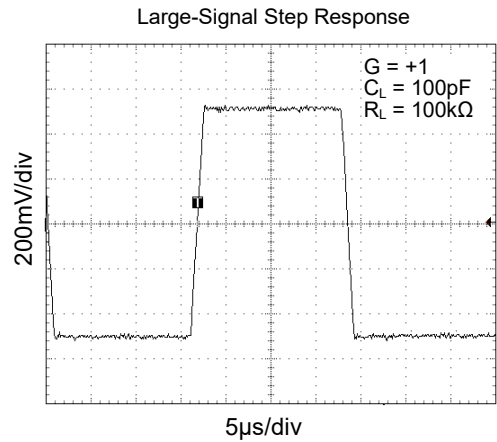
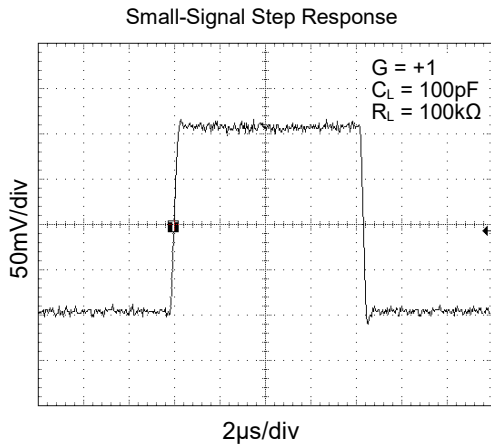
PARAMETER	CONDITIONS	SGM2358				
		TYP	MIN/MAX OVER TEMPERATURE			
		+25°C	+25°C	-40°C to +85°C	UNITS	MIN/MAX
<b>Input Characteristics</b>						
Input Offset Voltage (V <sub>OS</sub> )		1.8			mV	MAX
Common Mode Rejection Ratio (CMRR) <sup>(1)</sup>	V <sub>S</sub> = 2.5V, V <sub>CM</sub> = -0.1V to 0.9V	73			dB	MIN
Open-Loop Voltage Gain (A <sub>OL</sub> )	R <sub>L</sub> = 2kΩ, V <sub>OUT</sub> = 0.1V to 2.4V	99			dB	MIN
	R <sub>L</sub> = 10kΩ, V <sub>OUT</sub> = 0.035V to 2.465V	100			dB	MIN
<b>Output Characteristics</b>						
Output Voltage Swing from Rail	V <sub>OUT</sub> Connect R <sub>L</sub> (600Ω) to GND	0.130			V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (600Ω) to +V <sub>S</sub>	0.146			V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (2kΩ) to GND	0.043			V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (2kΩ) to +V <sub>S</sub>	0.049			V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (10kΩ) to GND	0.008			V	TYP
	V <sub>OUT</sub> Connect R <sub>L</sub> (10kΩ) to +V <sub>S</sub>	0.010			V	TYP
Output Current (I <sub>OUT</sub> )	V <sub>OUT</sub> = +V <sub>S</sub> - 0.5V	5.8			mA	TYP
	V <sub>OUT</sub> = -V <sub>S</sub> + 0.5V	-6.0			mA	TYP
Short-Circuit Current (I <sub>SC</sub> )	V <sub>OUT</sub> Connect R <sub>L</sub> (10Ω) to GND	9.1			mA	MIN
	V <sub>OUT</sub> Connect R <sub>L</sub> (10Ω) to +V <sub>S</sub>	-11.1			mA	MAX
<b>Power Supply</b>						
Quiescent Current (I <sub>Q</sub> )	I <sub>OUT</sub> = 0	0.19			mA	MAX
<b>Dynamic Performance</b>						
Gain-Bandwidth Product (GBP)	C <sub>L</sub> = 100pF	1.2			MHz	TYP
Slew Rate (SR)	G = +1, 1V Output step	0.34			V/μs	TYP
Settling Time to 0.1% (t <sub>S</sub> )	G = +1, 0.5V Output step	1.49			μs	TYP
Overload Recovery Time	V <sub>IN</sub> • Gain = V <sub>S</sub>	2.3			μs	TYP
<b>Noise Performance</b>						
Voltage Noise Density (e <sub>n</sub> )	f = 1kHz	46.8			nV/√Hz	TYP
	f = 10kHz	40.5			nV/√Hz	TYP

## NOTE:

1. CMRR is affected by the matching between external gain-setting resistor ratios.

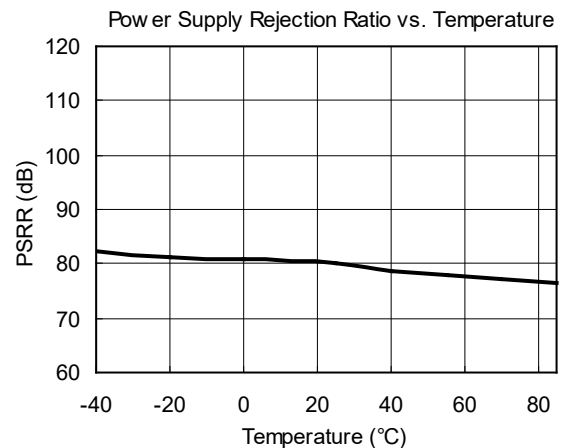
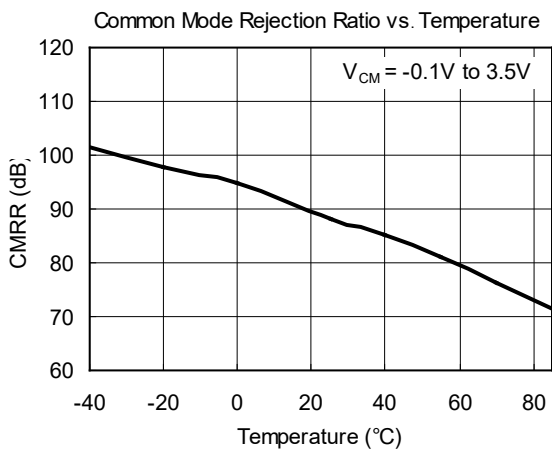
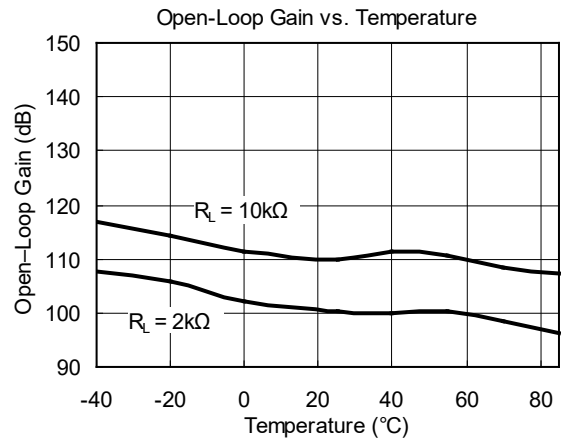
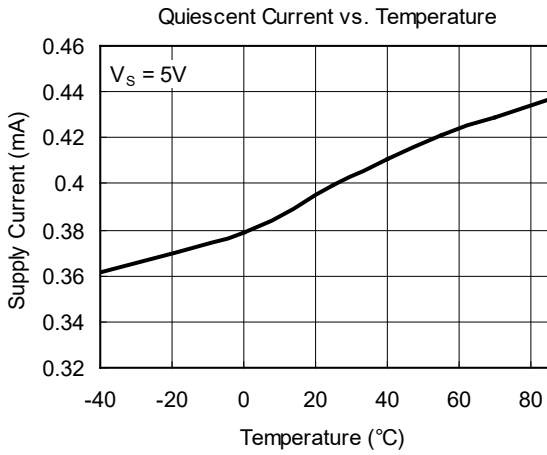
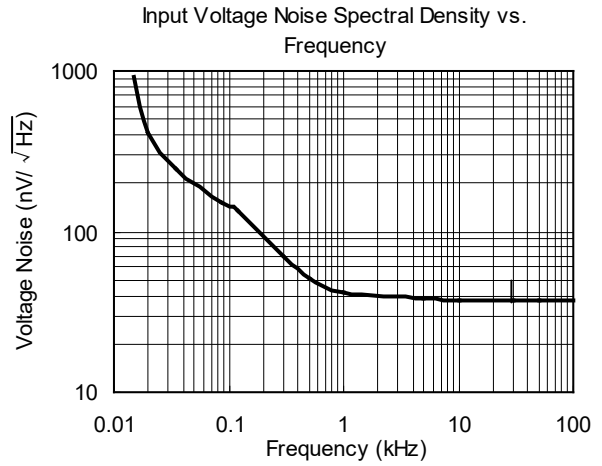
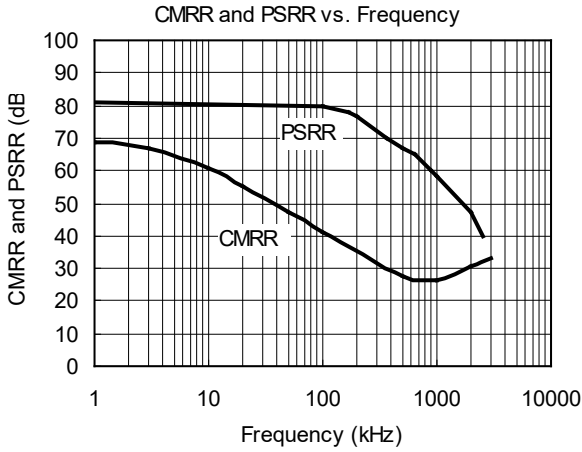
**TYPICAL PERFORMANCE CHARACTERISTICS**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$ , unless otherwise noted.



**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

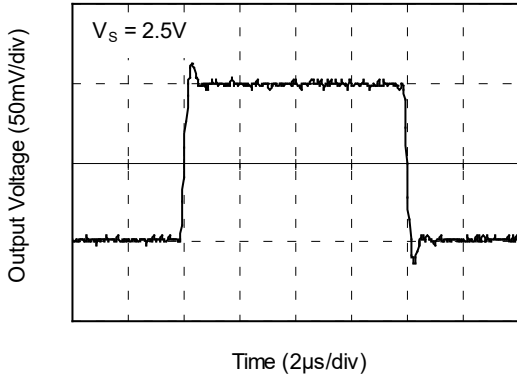
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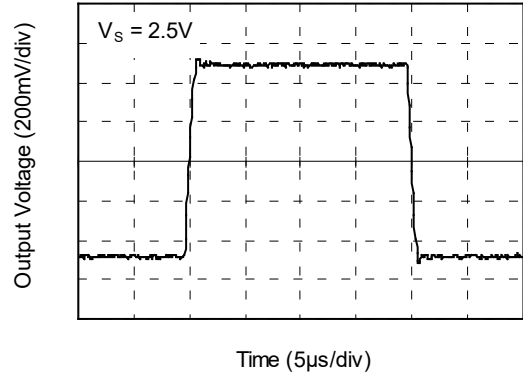
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$ , unless otherwise noted.

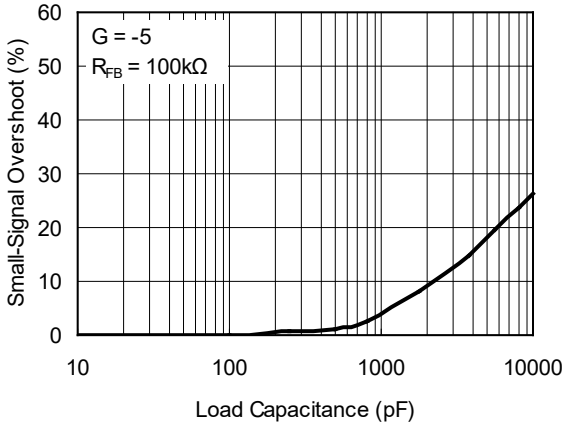
Small-Signal Step Response



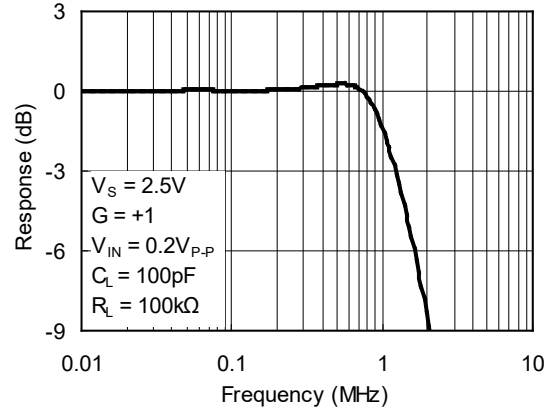
Large Signal Step Response



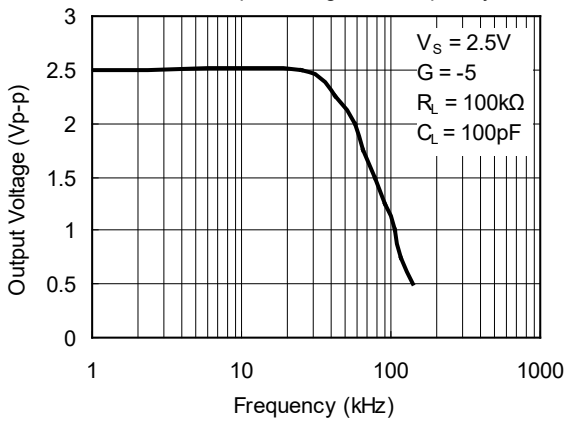
Small-Signal Overshoot vs. Load Capacitance



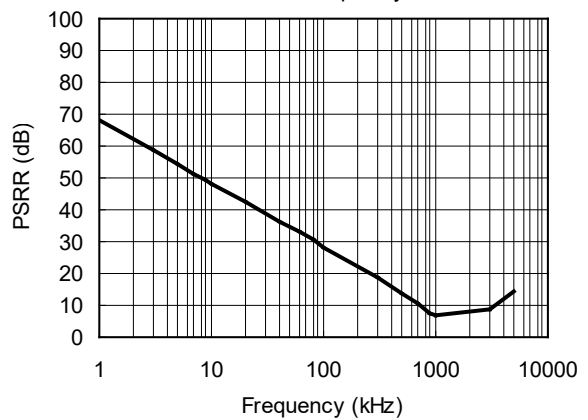
Response vs. Frequency



Maximum Output Voltage vs. Frequency

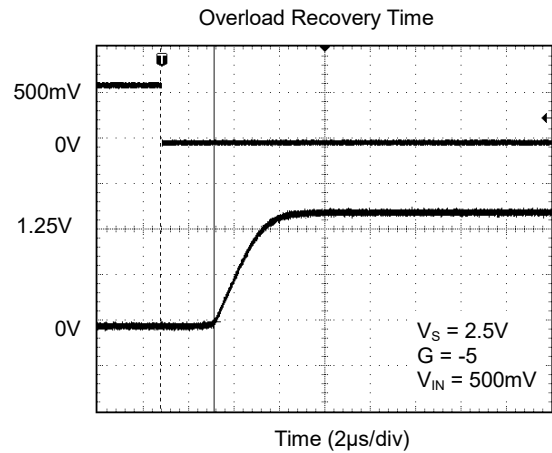
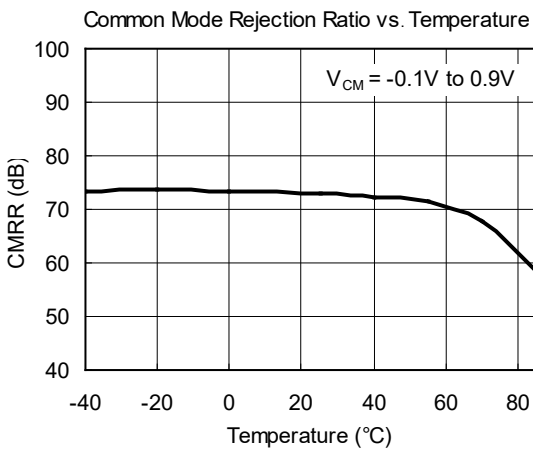
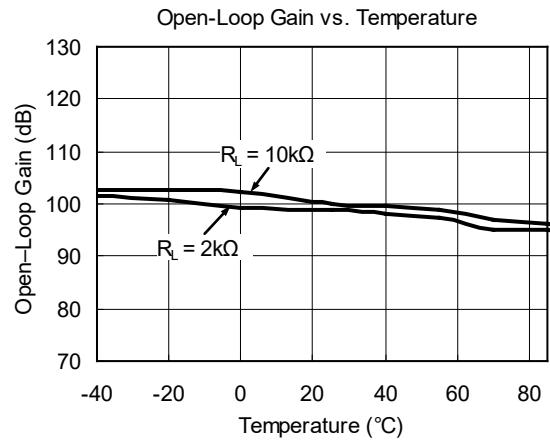
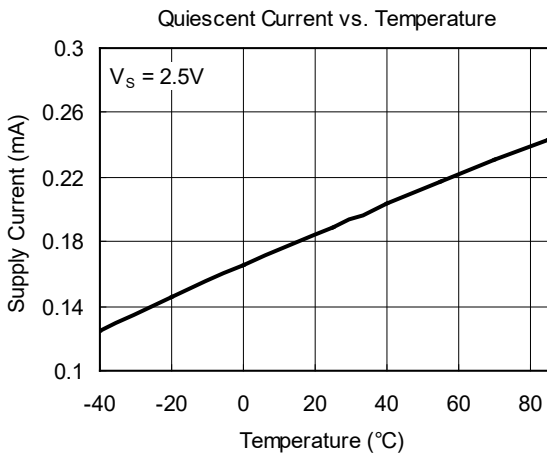
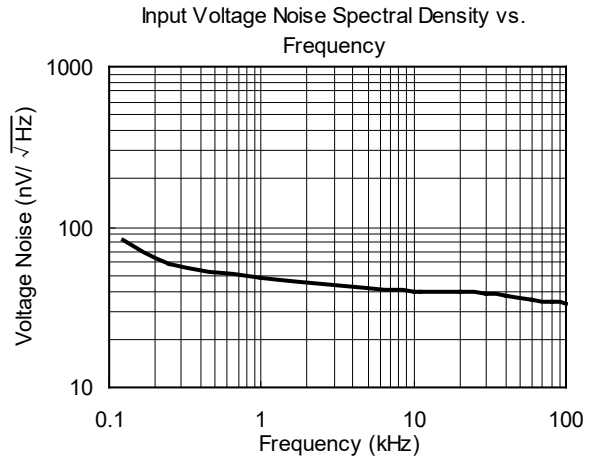
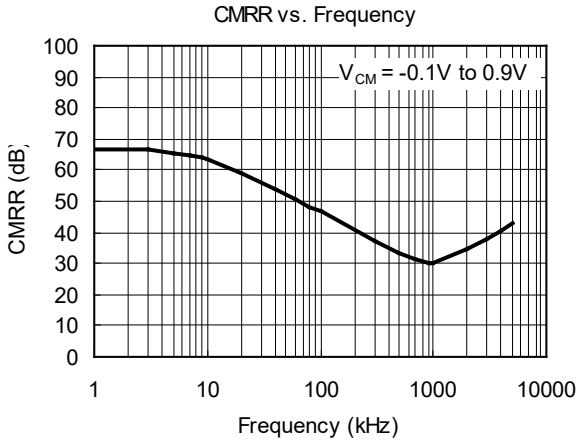


PSRR vs. Frequency



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

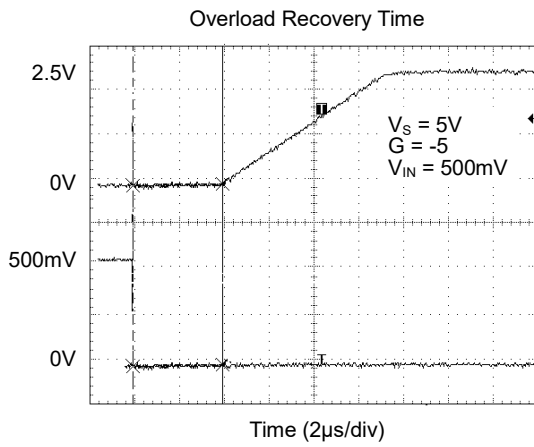
At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$ , unless otherwise noted.





**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$ , unless otherwise noted.



**APPLICATION INFORMATION**

**Rail-to-Rail Output**

The SGM2358 supports rail-to-rail output operation. In single power supply application, for example, when  $+V_S = 5V$ ,  $-V_S = GND$ ,  $10k\Omega$  load resistor is tied from OUT pin to ground, the typical output swing range is from 0.008V to 4.992V.

**Driving Capacitive Loads**

The SGM2358 is designed for unity-gain stable for capacitive load up to 250pF. If greater capacitive load must be driven in application, the circuit in Figure 1 can be used. In this circuit, the IR drop voltage generated by  $R_{ISO}$  is compensated by feedback loop.

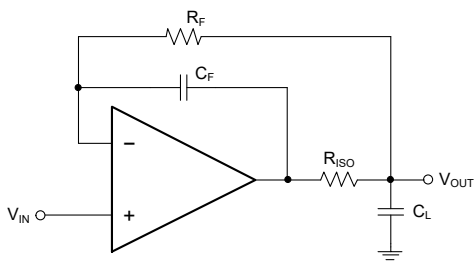


Figure 1. Circuit to Drive Heavy Capacitive Load

**Power Supply Decoupling and Layout**

A clean and low noise power supply is very important in amplifier circuit design, besides of input signal noise, the power supply is one of important source of noise to the amplifier through  $+V_S$  and  $-V_S$  pins. Power supply bypassing is an effective method to clear up the noise at power supply, and the low impedance path to ground of decoupling capacitor will bypass the noise to GND. In application,  $10\mu F$  ceramic capacitor paralleled with  $0.1\mu F$  or  $0.01\mu F$  ceramic capacitor is used in Figure 2. The ceramic capacitors should be placed as close as possible to  $+V_S$  and  $-V_S$  power supply pins.

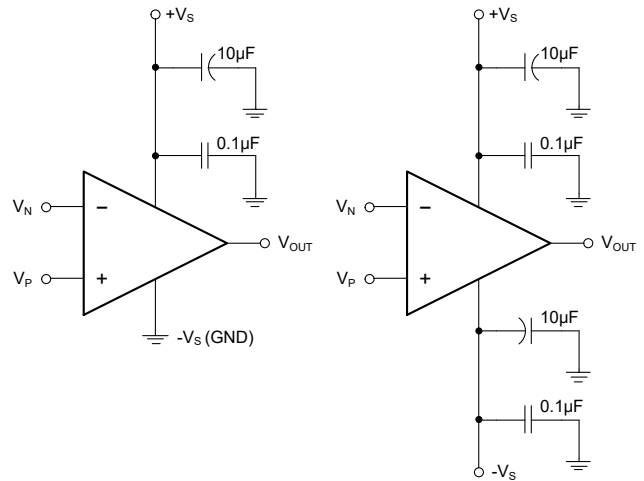


Figure 2. Amplifier Power Supply Bypassing

APPLICATION INFORMATION (continued)

Typical Application Circuits

Difference Amplifier

The circuit in Figure 3 is a design example of classical difference amplifier. If  $R_4/R_3 = R_2/R_1$ , then  $V_{OUT} = (V_P - V_N) \times R_2/R_1 + V_{REF}$ .

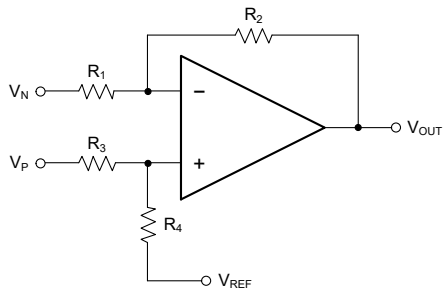


Figure 3. Difference Amplifier

High Input Impedance Difference Amplifier

The circuit in Figure 4 is a design example of high input impedance difference amplifier, the added amplifiers at the input are used to increase the input impedance and eliminate drawback of low input impedance in Figure 3.

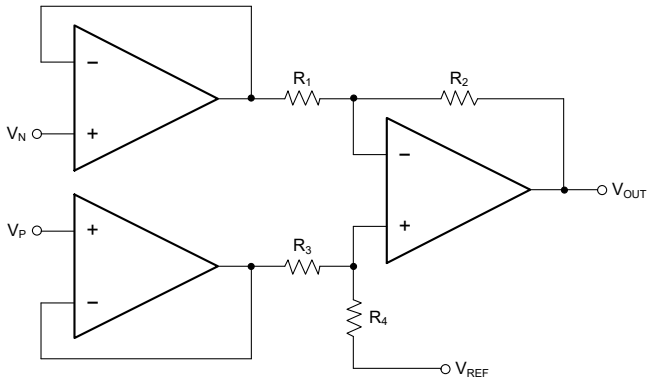


Figure 4. High Input Impedance Difference Amplifier

Active Low-Pass Filter

The circuit in Figure 5 is a design example of active low-pass filter, the DC gain is equal to  $-R_2/R_1$  and the -3dB corner frequency is equal to  $1/2\pi R_2 C$ . In this design, the filter bandwidth must be less than the bandwidth of the amplifier, the resistor values must be selected as low as possible to reduce ringing or oscillation generated by the parasitic parameters in PCB layout.

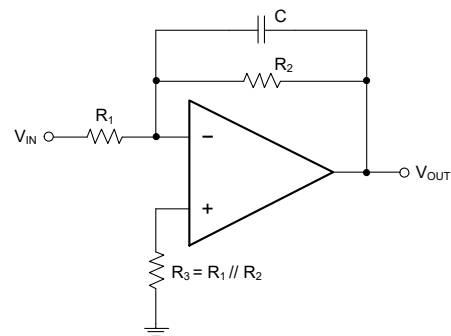


Figure 5. Active Low-Pass Filter

**REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

**MARCH 2017 – REV.B.4 to REV.C**

**Page**

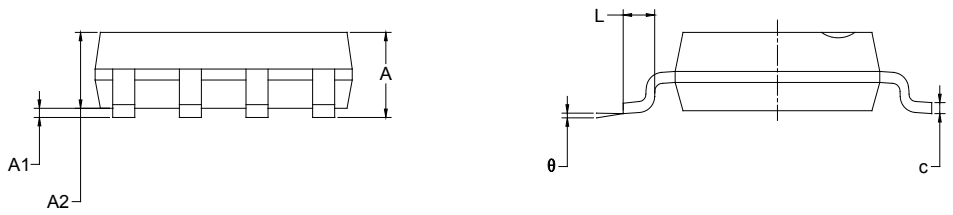
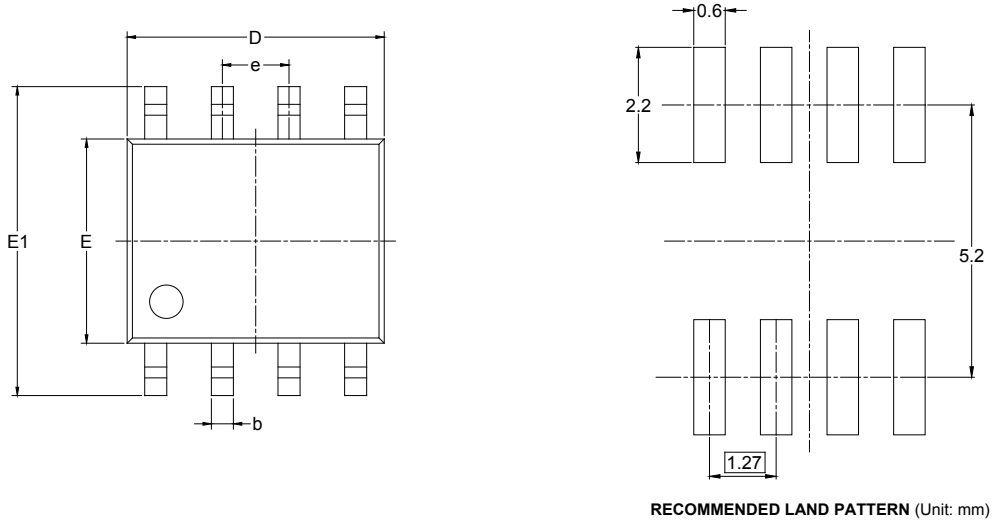
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Updated Package/Ordering Information section .....	2
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PACKAGE OUTLINE DIMENSIONS

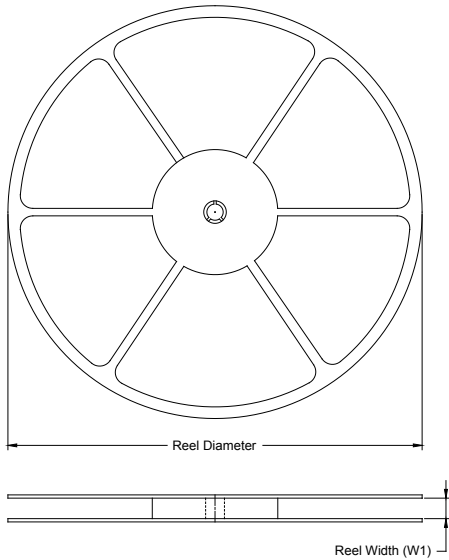
SOIC-8



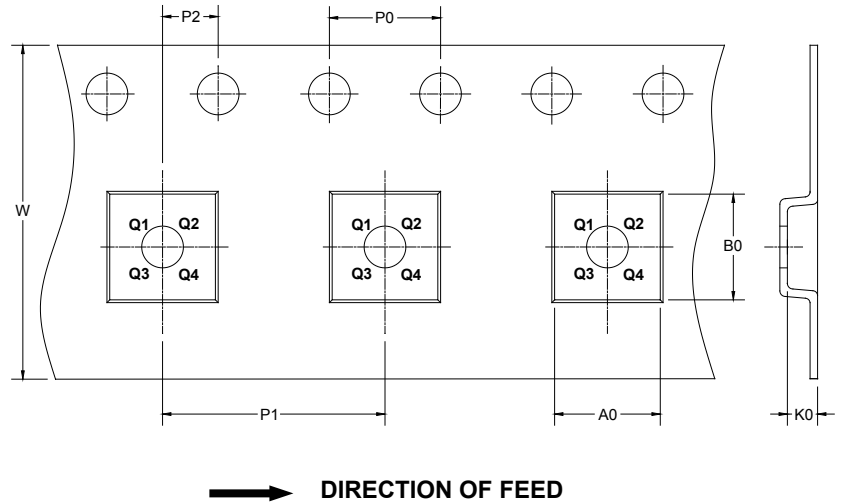
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**



**TAPE DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

**KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1

DD0001

# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002